

Inline PCB Inspection System VT-RNSI

OMRON

For Even More Efficient SMT Production Introducing the 2nd Generation RNS Series

VT-RNSI



Make Your SMT Production More Efficient while Achieving Zero Defects

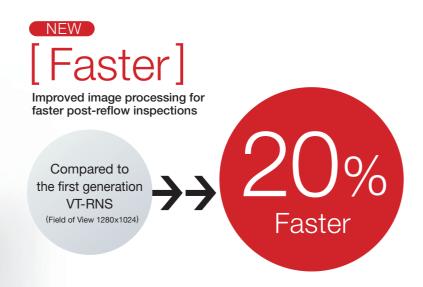


PCB Inspection System

VT-RNSI

Four advantages only Omron can provide

Omron's second-generation, in-line PCB inspection system the VT-RNS II, delivers fast and reliable results to prevent defective boards from reaching your customer. We simplified the inspection program generation process with our easy-to-use EzTS software to efficiently handle high mix/low volume production. Omron has reduced post-reflow inspection times by 20% by utilizing faster shutter speeds and improved image processing.



[Quick Setup] [Highly Accurate] [Expandable]

So easy that anyone can set up inspection programs.

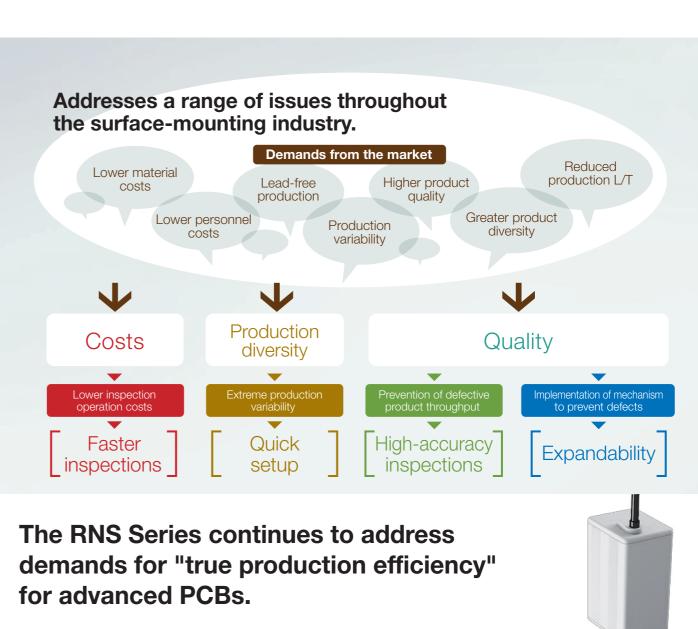
EzTS (Ez-image Teaching) system makes setting-up easy for anyone

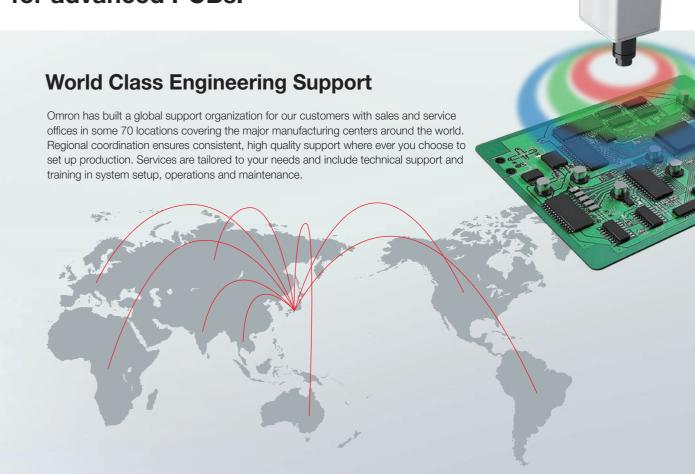
Omron's 3CCD camera and Color Highlight Technology provide the most accurate inspection capability.

3-CCD camera plus Color Highlight system

Omron has the expertise to boost your production efficiency.

Q-upNavi provides total support for process improvement





Maximize your SMT line throughput with the use of quick setup and highly accurate inspection capability.

Fast production system startup and stable operation with no downtime. Inspection system performance is the key.

The VT-RNS II delivers outstanding performance at every step of production. Easy-to-set initial inspection parameters are ready for immediate use to perform high accuracy inspections. Data collected from the inspection stations can be analyzed for root cause analysis of defects for ongoing process improvement. Omron gives you the tools to increase productivity on your PCB assembly lines.



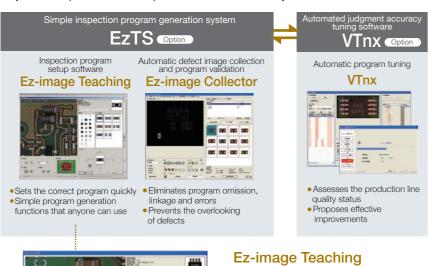
Program setup

Create inspection programs quickly for immediate line operation

[Quick Setup]

Features EzTS for simple automated generation of inspection programs

The easy-to-use Ez-Image Teaching (Ez-IT) inspection program generation software is equipped as a standard feature, enabling anyone to quickly and easily create inspection programs tailored to the PCB. The software also validates the inspection programs so that they can be implemented on the production line without delay.





Simple program generation procedure

Select the most appropriate model.

Match it to the component shape

Adjust the angle, etc

* Note that this is not supported for some PCBs. Contact your Omron sales representative for details.



Inspection

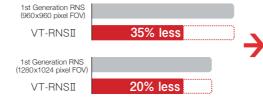
20% Faster, highly accurate inspection system

[Faster]

Improved image processing for faster post-reflow inspections

In addition to processing faster than that of conventional models, the VT-RNSII also features revamped imaging processes to achieve significantly faster outcomes. This enables the system to cope with the most demanding production environments.

Processing Speed compared with first generation VT-RNS



Advantages of higher speeds flow through to all production processes

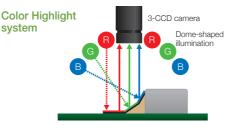
Increased speeds enables the use of higher magnification inspections for the ever increasing density of printed circuit boards.

* Only on post-reflow inspection systems. Effectiveness varies depending on the PCB inspected.

[Highly Accurate]

Uses Omron's 3-CCD and Color Highlight Technology

Omron pioneered the development of 3-CCD and Color Highlight Technology in PCB inspection systems to obtain correct measurements with high levels of inspection accuracy.





The Color Highlight technology provides a way of obtaining accurate information on solder joint angles in the form of image data.

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Process Improvement

VT-RNS T

Root cause defect analysis for a Process Improvement Support System

[Expandable]

Q-upNavi provides total support for process improvement, root cause defect analysis and countermeasure implementation

Q-upNavi is quality control software that analyzes inspection results and provides feedback to the production line. This software enables operators to implement corrective procedures that will prevent future defects from occurring regardless of their level of experience or expertise.

Process Improvement Support System

Q-upNavi option



Q-upNavi helps you implement procedures to ensure that defects do not occur.

Configuration/Specifications

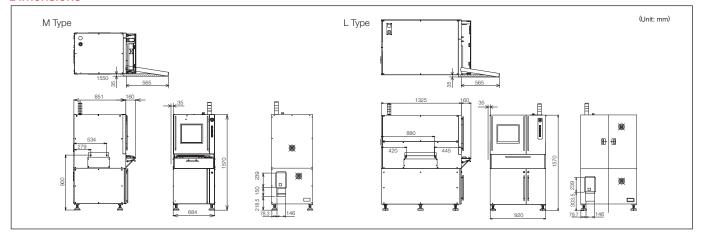
Hardware Configuration

		M size	L size			
		P/Z/S				
Image signal input unit	Camera	3-CCD camera				
	Illumination	Ring-shaped LEDs (R, G, B)				
	Image resolution	10, 15, 20 μm				
Main unit	Feed method	Belt				
	Line height	900±15 mm				
	PCB carrier width adjustment	Automatic				
PCB fixing method		Outer frame				
Power supply		AC100 / 115 V / 120 V / 200 V / 220 V / 230 V / 240 V ±10% (single phase)				
Air		0.4 to 0.6 Mpa				
Ambient operating temperature		+10 to +35°C				
Ambient operating humidity		35 to 80% RH (with no condensation)				
Weight		Approx. 500 kg	Approx. 650 kg			
Dimensions		700(W)×900(D)×1,600(H) mm (Excluding Patlite signal tower)	920(W)×1,365(D)×1,600(H) mm (Excluding Patlite signal tower)			

Functional Specifications

		M size			L size				
		Р	Z	S	Р	Z	S		
	Туре	Post-printing	Post-placement (before reflow)	Post-reflow	Post-printing	Post-placement (before reflow)	Post-reflow		
Inspectable PCBs	Dimensions	50(W)×50(D) to 333(W)×255(D) mm			80(W)×50(D) to 510(W)×460(D) mm 80(W)×110(D) to 510(W)×460(D) mm (with PCB warpage correction unit)				
	Thickness	0.3 to 2.5 mm			0.3 to 3.0 mm				
Clearance		Above PCB: 20 mm (0.79 in) (standard), 40 mm (1.57 in) (optional) Below PCB: 40 mm (1.57 in)		Above PCB: 20 mm (0.79 in) (standard), 40 mm (1.57 in) (optional) Below PCB: 50 mm (1,97 in)					
Inspection items		Presence of solder, insufficient/excessive solder, solder shifting, grazing, bridging, spreading, leaking	Presence of solder, component shifting, polarity error, missing components, wrong components, solder balls, skewing, bridging, foreign objects	Presence of solder, wrong components, missing components, bridging, lifting, component shifting, fillets, wettability, lead bending, adhesive, solder balls	Presence of solder, insufficient/excessive solder, solder shifting, grazing, bridging, spreading, leaking	error, missing components,	Presence of solder, wrong components, missing components, bridging, lifting, component shifting, fillets, wettability, lead bending, adhesive, solder balls		
Number of inspection points		40,000 lands/PCB max.	10,000 compor	nents/PCB max.	40,000 lands/PCB max.	10,000 components/PCB max.			
Data storage		Computer hard disk							
Component-specific inspection data library		Component types, groups, variations							
Inspection result output		PCB name, PCB ID, component name, type of fault, etc.							
Communications		Ethernet, RS-232C							
PCB feed mode		Through, turnback							
Reference position		PCB feed direction: left or right (selected at shipment); Longitudinal: Front or back (selected at shipment)							

Dimensions



• This product may cause interference if used in residential areas.

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